

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :
Norihito TSUKAHARA et al. :
Serial No. NEW : **Attn: APPLICATION BRANCH**
Filed December 17, 2003 : Attorney Docket No. 2003_1827

SEMICONDUCTOR DEVICE PACKAGE
MANUFACTURING METHOD AND
SEMICONDUCTOR DEVICE PACKAGE
MANUFACTURED BY THE METHOD
**(Rule 1.53(b) Continuation
of Serial No. 10/031,000,
Filed January 16, 2002)**

CLAIM OF PRIORITY UNDER 35 USC 119

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450


Sir:

Applicants in the above-entitled application hereby claim the date of priority under the International Convention of Japanese Patent Application No. 11-202847, filed July 16, 1999 and Japanese Patent Application No. 2000-63686, filed March 8, 2000, as acknowledged in the Declaration of this application.

The priority documents were received by the International Bureau on September 4, 2000. A copy of the Form PCT/IB/304 is of record in parent application No. 10/031,000.

Respectfully submitted,

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December 17, 2003